

High Voltage (Up to 3 kV) Thick Film Chip Resistors



LINKS TO ADDITIONAL RESOURCES



The RCV e3 high voltage thick film chip resistors series is the perfect choice for modern electronics with high voltage requirements. Typical applications include E-meter, AC power supplies, lighting ballasts and inverters for industrial drives, aircons, and white good.

FEATURES

- High operating voltage (up to 3 kV)
- Low voltage coefficient of resistance (VCR): 25 ppm/V
- UL 1676 recognition for RCV2010 e3 and RCV2512 e3 only; UL file no. E526561
- IEC 62368-1 ed. 3 compliant for RCV2010 e3 and RCV2512 e3 only
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- E-meter
- Inverters for industrial drives, aircons, and white good
- AC power supplies
- Lighting ballasts

TECHNICAL SPECIFICATIONS				
DESCRIPTION	RCV0805 e3	RCV1206 e3	RCV2010 e3	RCV2512 e3
Imperial size	0805	1206	2010	2512
Metric size code	RR2012M	RR3216M	RR5025M	RR6332M
Resistance range	100 kΩ to 10 MΩ		100 kΩ to 100 MΩ	
Resistance tolerance	± 5 %; ± 1 %			
Temperature coefficient	± 200 ppm/K; ± 100 ppm/K			
Voltage coefficient	25 ppm/V			
Rated dissipation, P_{70} ⁽¹⁾	0.125 W	0.33 W	0.75 W	1 W
Operating voltage, U_{max} . AC _{RMS} /DC	400 V	800 V	2000 V	3000 V
Permissible film temperature, $\vartheta_{\text{F max.}}$ ⁽¹⁾	155 °C			
Operating temperature range	-55 °C to +155 °C			
Max. resistance change at P_{70} for resistance range, $ \Delta R/R $ after:				
1000 h	≤ 1.0 %	≤ 1.0 %	≤ 2.0 %	≤ 2.0 %
Approval UL 1676 recognition file	-	-	E526561	
Approval IEC 62368-1			Ed. 3 approved	
Permissible voltage against ambient (insulation):				
1 min, U_{ins}	500 V			

Notes

- Application-specific safety requirements may set limitations to the applicability of the specified voltage
- ⁽¹⁾ Please refer to APPLICATION INFORMATION below

APPLICATION INFORMATION

When the resistor dissipates power, a temperature rise above the ambient temperature occurs, dependent on the thermal resistance of the assembled resistor together with the printed circuit board. The rated dissipation applies only if the permitted film temperature is not exceeded.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.

**TEMPERATURE COEFFICIENT AND RESISTANCE RANGE**

TYPE / SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES
RCV0805 e3	± 200 ppm/K	± 5 %	100 kΩ to 10 MΩ	E24
	± 100 ppm/K	± 1 %	100 kΩ to 10 MΩ	E24; E96
RCV1206 e3	± 200 ppm/K	± 5 %	100 kΩ to 51 MΩ	E24
	± 100 ppm/K	± 1 %	100 kΩ to 10 MΩ	E24; E96
RCV2010 e3	± 200 ppm/K	± 5 %	100 kΩ to 100 MΩ	E24
	± 100 ppm/K	± 1 %	100 kΩ to 10 MΩ	E24; E96
RCV2512 e3	± 200 ppm/K	± 5 %	100 kΩ to 100 MΩ	E24
	± 100 ppm/K	± 1 %	100 kΩ to 10 MΩ	E24; E96

PACKAGING

TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	PACKAGING DIMENSIONS
RCV0805 e3	EA = ET1	5000	Paper tape according to IEC 60286-3, type 1a	8 mm	4 mm	Ø 180 mm / 7"
	EC = ET6	20 000				Ø 330 mm / 13"
RCV1206 e3	EA = ET1	5000				Ø 180 mm / 7"
	EC = ET6	20 000				Ø 330 mm / 13"
RCV2010 e3	EF = E02	4000	Blister tape according to IEC 60286-3, type 2a	12 mm	4 mm	Ø 180 mm / 7"
RCV2512 e3	EG = E67	2000			8 mm	Ø 180 mm / 7"
	EH = E82	4000			4 mm	

PART NUMBER AND PRODUCT DESCRIPTION

Part Number: RCV1206100KFKEA

R	C	V	1	2	0	6	1	0	0	K	F	K	E	A
---	---	---	---	---	---	---	---	---	---	---	---	---	---	---

TYPE / SIZE	RESISTANCE	TOLERANCE	TCR	PACKAGING
RCV0805 RCV1206 RCV2010 RCV2512	K = thousand M = million	F = ± 1 % J = ± 5 %	K = ± 100 ppm/K N = ± 200 ppm/K	EA, EC, EF, EG, EH

Product Description: RCV1206 100 100K 1 % ET1 e3

RCV1206	100	100K	1 %	ET1	e3
TYPE / SIZE	TCR	RESISTANCE	TOLERANCE	PACKAGING	LEAD (Pb)-FREE
RCV0805 RCV1206 RCV2010 RCV2512	± 100 ppm/K ± 200 ppm/K	100K = 100 kΩ 1M = 1 MΩ 10M = 10 MΩ 100M = 100 MΩ	± 1 % ± 5 %	ET1, ET6, E02, E67, E82	e3 = pure tin termination finish



DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A cermet film layer and a glass-over are deposited on a high grade (Al_2O_3) ceramic substrate. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly fine trimming the resistive layer without damaging the ceramics. The resistor elements are covered by a protective coating designed for electrical, mechanical, and climatic protection. The terminations receive a final pure matte tin on nickel plating. The result of the determined production is verified by an extensive testing procedure on 100 % of the individual chip resistors. Only accepted products are laid directly into the tape in accordance with **IEC 60286-3 type 1a and 2a** ⁽¹⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapor phase as shown in **IEC 61760-1** ⁽¹⁾. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters, and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS-compliant, the pure matte tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein ⁽²⁾
- The Global Automotive Declarable Substance List (GADSL) ⁽³⁾
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) ⁽⁴⁾ for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see www.vishay.com/how/leadfree.

Notes

- ⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents
- ⁽²⁾ The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at <http://std.iec.ch/iec62474>
- ⁽³⁾ The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at www.gadsl.org
- ⁽⁴⁾ The SVHC list is maintained by the European Chemical Agency (ECHA) and available at <http://echa.europa.eu/candidate-list-table>

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

APPROVALS

Where applicable, the resistors are tested in accordance with **EN 140401-802** which refers to **EN 60115-1**, **EN 60115-8** and the variety of environmental test procedures of the **IEC 60068** ⁽¹⁾ series.

Products RCV2010 e3 and RCV2512 e3 only, are additionally tested in accordance with UL 1676 and IEC 62368-1, ed. 3.

Recognition by Underwriter Laboratories Inc. is indicated by the UL logo on the package label.

RELATED PRODUCTS

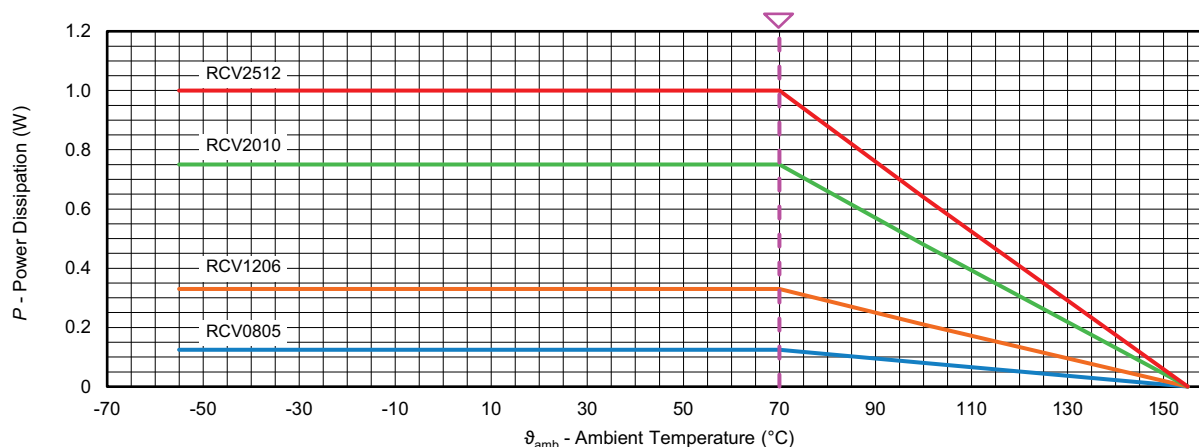
For high voltage, automotive thick film products, please refer to latest edition of RCV-AT e3, High Voltage (Up to 3 kV) Thick Film Chip Resistors datasheet, www.vishay.com/doc?20082.

For high voltage thin film products, please refer to latest edition of TNPV e3, High Voltage Thin Film Chip Resistors datasheet, www.vishay.com/doc?28881.

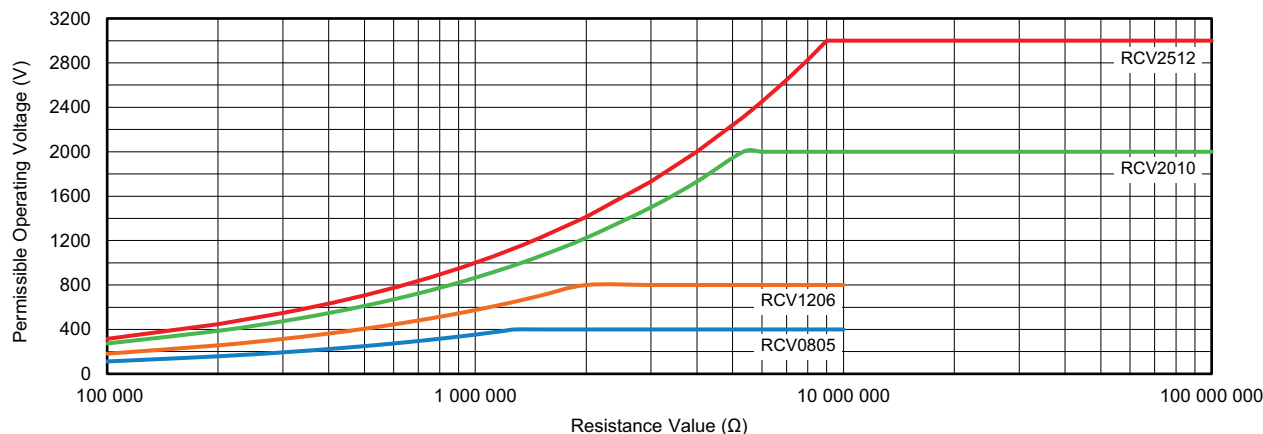
For products with professional specification, please refer to latest edition of MMA0204 HV, MMB0207 HV, Professional High Voltage Thin Film MELF Resistors datasheet, www.vishay.com/doc?28880.

For tighter precision specification, automotive high voltage thin film, please refer to latest edition of MMA 0204 HV AT, MMB 0207 HV AT, Precision Automotive High Voltage Thin Film MELF Resistors datasheet, www.vishay.com/doc?28951.

DERATING



NOMINAL OPERATING VOLTAGE



The permissible operating voltage U_{max} equals the rated voltage.
For ambient temperatures above 70 °C power derating must be considered

TESTS AND REQUIREMENTS

All executed tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 60115-8, sectional specification

EN 140401-802, detail specification

IEC 60068-2-xx, test methods

UL 1676 - Conductive-Path and Discharge-Path Resistors

IEC 62368-1 Audio / Video, Information and Communication Technology Equipment, Part 1: Safety Requirements ed. 3

The parameters stated in the "Test Procedures and Requirements" table are based on the required tests and permitted limits of EN 140401-802. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included.

The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

Temperature: 15 °C to 35 °C

Relative humidity: 25 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

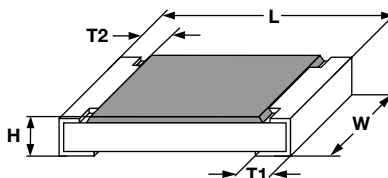
A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60082-2 ⁽¹⁾ TEST METHOD	TEST	PROCEDURE			REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
			Stability for product types:			STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			RCV e3			100 k Ω to 100 M Ω	
6.1	-	Measurements of resistance and tolerance	-			$\pm 1 \%$	$\pm 5 \%$
6.2	-	Temperature coefficient of resistance	At (20 / -55 / 20) °C and (20 / 155 / 20) °C			± 100 ppm/K	± 200 ppm/K
7.1	-	Endurance at rated temperature 70 °C	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$ whichever is the less severe; 1.5 h on; 0.5 h off 70 °C; 1000 h			RCV0805, RCV1206: $\pm (1 \% R + 0.05 \Omega)$ RCV2010, RCV2512: $\pm (2 \% R + 0.1 \Omega)$	
7.3	-	Endurance at maximum temperature	155 °C; 1000 h			$\pm (2 \% R + 0.1 \Omega)$	
10.4	78 (Cab)	Damp heat, steady state	(40 \pm 2) °C; 56 days; (93 \pm 3) % RH			$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
10.3	-	Climatic sequence:	125 °C; 16 h			$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
10.3.4.2	2 (Bb)	Dry heat	55 °C; 24 h; $\geq 90 \%$ RH; 1 cycle				
10.3.4.3	30 (Db)	Damp heat, cyclic	-55 °C; 2 h				
10.3.4.4	1 (Ab)	Cold	8.5 kPa; 2 h; (25 \pm 10) °C				
10.3.4.5	13 (M)	Low air pressure	55 °C; 5 days; $> 90 \%$ RH; 5 cycles				
10.3.4.6	30 (Db)	Damp heat, cyclic	$U = \sqrt{P_{70} \times R} \leq U_{max.}$; 1 min				
10.3.4.7	-	DC load					
-	1 (Aa)	Cold	-55 °C; 2 h			$\pm (0.5 \% R + 0.05 \Omega)$	
10.1	14 (Na)	Rapid change of temperature	30 min. at -55 °C and 30 min. at 125 °C; RCV0805, RCV1206: 1000 cycles RCV2010, RCV2512: 100 cycles			$\pm (1 \% R + 0.05 \Omega)$ no visible damage	
8.1	-	Short-term overload	$U = 2.5 \times \sqrt{P_{70} \times R} \leq 2 \times U_{max.}$; whichever is the less severe; 5 s			RCV0805, RCV1206: $\pm (0.25 \% R + 0.05 \Omega)$ RCV2010, RCV2512: $\pm (2.0 \% R + 0.05 \Omega)$	
			Style	Duration	Maximum U_{OL}		
			RCV0805	1 s	800		
			RCV1206	2 s	1000		
			RCV2010	5 s	4000		
			RCV2512	5 s	6000		
8.2	-	Single pulse high voltage overload 10 μ s / 700 μ s	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.}$; whichever is the less severe; 10 pulses			$\pm (2 \% R + 0.1 \Omega)$ no visible damage	
8.4	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R}$ or $U = 2 \times U_{max.}$; whichever is the less severe; 0.1 s on; 2.5 s off; 1000 cycles			$\pm (2 \% R + 0.05 \Omega)$ no visible damage	
8.5	-	Electrostatic discharge (human body model)	IEC 61340-3-1 ⁽¹⁾ ; 3 positive + 3 negative discharges; RCV0805: 1000 V RCV1206: 2000 V RCV2010: 12 kV RCV2512: 25 kV			$\pm (1 \% R + 0.05 \Omega)$	
9.11	6 (Fc)	Vibration	Endurance by sweeping f = 10 Hz to 2000 Hz; no resonance; A ≤ 1.5 mm ≤ 200 m/s ² ; 7.5 h			$\pm (0.25 \% R + 0.05 \Omega)$ no visible damage	$\pm (0.5 \% R + 0.05 \Omega)$ no visible damage
11.1	58 (Td)	Solderability	Solder bath method, SnPb40; non-activated flux (235 \pm 5) °C; (2 \pm 0.2) s			Good tinning ($\geq 95 \%$ covered); no visible damage	
			Solder bath method, Sn96.5Ag3Cu0.5; non-activated flux (245 \pm 5) °C; (3 \pm 0.3) s				
11.2	58 (Td)	Resistance to soldering heat	Soldering bath method; (260 \pm 5) °C; (10 \pm 1) s			$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$

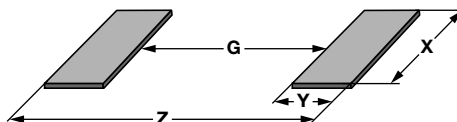
TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60082-2 ⁽¹⁾ TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
			Stability for product types:	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			RCV e3		
11.3	45 (XA)	Component solvent resistance	Isopropyl alcohol; +50 °C; method 2	No visible damage	
9.7	21 (Uu ₃)	Shear (adhesion)	17.7 N	No visible damage	
9.8	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	RCV0805, RCV1206: ± (0.25 % <i>R</i> + 0.05 Ω) RCV2010, RCV2512: ± (1 % <i>R</i> + 0.05 Ω) no visible damage, no open circuit in bent position	
12.2	-	Voltage proof	<i>U</i> = 1.4 x <i>U</i> _{ins} ; 60 s	No flashover or breakdown	
12.4	-	Flammability, needle flame test	IEC 60695-11-5 ⁽¹⁾ ; 10 s	No burning after 30 s	

Note

⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents

DIMENSIONS


DIMENSIONS AND MASS						
TYPE / SIZE	L (mm)	W (mm)	H (mm)	T1 (mm)	T2 (mm)	MASS (mg)
RCV0805 e3	2.0 + 0.20 / - 0.10	1.25 ± 0.15	0.5 ± 0.10	0.3 + 0.20 / - 0.10	0.3 ± 0.20	5.5
RCV1206 e3	3.2 + 0.10 / - 0.20	1.6 ± 0.15	0.55 ± 0.05	0.45 ± 0.20	0.4 ± 0.20	10
RCV2010 e3	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.10	0.6 ± 0.20	0.45 ± 0.20	25.5
RCV2512 e3	6.3 ± 0.20	3.15 ± 0.15	0.6 ± 0.10	0.6 ± 0.20	0.45 ± 0.20	42

SOLDER PAD DIMENSIONS


RECOMMENDED SOLDER PAD DIMENSIONS								
TYPE / SIZE	WAVE SOLDERING				REFLOW SOLDERING			
	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
RCV0805 e3	0.90	1.30	1.60	3.50	1.00	0.95	1.45	2.90
RCV1206 e3	1.40	1.40	1.95	4.20	1.50	1.05	1.80	3.60
RCV2010 e3	3.60	1.65	2.85	6.90	3.70	1.20	2.70	6.10
RCV2512 e3	4.90	1.60	3.50	8.10	5.00	1.25	3.35	7.50

Note

- Utilization of the full specified operating voltage may require special considerations on the creepage and clearance distance between conductors at different potential levels



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.